

**TITLE**

**SELF-ALIGNED FABRICATION PROCESS FOR A NOZZLE PLATE OF AN**  
**INKJET PRINT HEAD**

**BACKGROUND OF THE INVENTION**

**5 Field of the Invention**

The invention relates to a method of forming a nozzle plate of an inkjet print head, and more particularly to a self-aligned fabrication process for a nozzle plate of an inkjet print head.

**10 Description of the Related Art**

Inkjet printers, accurately and rapidly drive ink droplets of precise volume in predetermined positions to print, and as such satisfy demands for automation, miniaturization, low cost, reduced-time procedures, and environmental concerns in the electronics industry. Particularly, thermal inkjet print heads employ a heater to vaporize ink droplets, and use high-pressure bubbles to drive the ink droplets through nozzle orifices to print. The inkjet print head comprises an ink cartridge, a nozzle plate having a plurality of nozzle orifices and a plurality of thin-film heaters, in which each thin-film heater is disposed under each nozzle orifice and is provided with an ink channel wall to drive ink droplets from corresponding nozzle orifices.

Print quality of the inkjet printer mainly depends on physical characteristics of the nozzle orifice of the inkjet print head, such as the undercut profile and the opening

profile of the nozzle orifice, which influence volume, track and jet speed of the ink droplets. Conventionally, the nozzle plate is a metal plate with a plurality of nozzle orifices formed by lithographic electroforming or other 5 electrochemical shaping technologies. However, the metal nozzle plate formed by lithographic electroforming encounters problems. First, the process conditions, such as stress and electroplating thickness, are difficult to control. Second, design choices of nozzle orifice shape and 10 size are limited. Third, the process cost is high for mass production. Fourth, the metal plate is easily corroded by the ink droplets. Although this corrosion phenomenon can be eliminated by electroplating an extra gold layer on the metal nozzle plate, the process cost is concurrently 15 increased.

Recently, an excimer laser treatment has been employed to form the nozzle orifices and solve the above-described problems, but other problems are encountered, such as misalignment, and bulky and expensive facilities.

20 Accordingly, a novel process of forming the nozzle plate for improved printing quality, simplified process, decreased process costs, and improved pattern precision, is called for.

#### **SUMMARY OF THE INVENTION**

25 Accordingly, an object of the invention is to provide a self-aligned fabrication process for a nozzle plate of an inkjet print head. The position, diameter, and profile of the nozzle orifice are effectively controlled to achieve simplified procedure, reduced cost, and improved precision.

To achieve these and other advantages, the invention provides a self-aligned fabrication process for a nozzle plate of an inkjet print head. First, a substrate is provided with an activated device and a first film is formed 5 on the substrate. Then, a second film is formed on the first film. Next, the second film is defined to form a convex portion corresponding to the activated device, exposing a part of the surface of the first film. Next, a third film is formed on the exposed surface of the first 10 film, covering the convex portion. The third film on the convex portion is then removed. Finally, the convex portion and the first film under the convex portion are etched to form a via.

According to the invention, the nozzles having better 15 performance than nozzles made by conventional electroforming are provided by a simplified fabrication process.

By directly forming nozzle orifices on the substrate, the conventional requirement of precise alignment between the nozzle orifices (on the metal nozzle plate) and the 20 activated devices (on the substrate) in an electroforming step is not required, and yield down resulting from misalignment is prevented.

Moreover, by appropriately selecting the materials of the first film and the third film to be hydrophilic and 25 hydrophobic respectively, the inkjet printing mechanism is facilitated, providing high-resolution inkjet performance.

#### **DESCRIPTION OF THE DRAWINGS**

For a better understanding of the present invention, reference is made to a detailed description to be read in conjunction with the accompanying drawings, in which:

5 FIGs. 1A to 1F are sectional diagrams of a self-aligned fabrication process for a nozzle plate of an inkjet print head according to the first embodiment; and

FIGs. 2A to 2F are sectional diagrams of a self-aligned fabrication process for a nozzle plate of an inkjet print  
10 head according to the second embodiment.

#### **DETAILED DESCRIPTION OF THE INVENTION**

The present invention provides a self-aligned fabrication process for a nozzle plate of an inkjet print head. On a substrate, laminating, exposure, development, 15 and etching are employed to form a plurality of nozzle orifices in a film, such that the position, diameter, and profile of the nozzle orifices are effectively controlled to simplify the procedure, reduce costs, and improve precision. The amount, arrangement, and size of the nozzle orifices are 20 design choices and not limited.

Two preferred embodiments of the present invention are now described with reference to a method of forming a nozzle orifice over an activated device (for example, a thin-film heater) of a silicon substrate.

25 **First Embodiment**

FIGs. 1A to 1F are sectional diagrams of a self-aligned fabrication process for a nozzle plate of an inkjet print head according to the first embodiment. In FIG. 1A, a

silicon substrate 10 is provided with at least one activated device 12, such as a thin-film heater, and then covered with a first film 14 by laminating or any other deposition type. Preferably, the first film 14 is a photosensitive polymeric material, such as epoxy, novolak, arcylate, polyimide, polyamide, or photosensitive polymer.

Next, in FIG. 1B, the first film 14 is covered with a second film 16 by laminating or other deposition method. Preferably, the second film 16 is also a photosensitive polymeric material, such as epoxy, novolak, arcylate, polyimide, polyamide, or photosensitive polymer.

Next, in FIG. 1C, using exposure and development on a predetermined area of the second film 16, a convex portion 18 is formed on the surface of the first film 14. By controlling the degree of exposure, the side wall of the convex portion 18 cross-section is formed in an arc shape, as shown in FIG. 1C.

Next, in FIG. 1D, a third film 20 is formed on the exposed surface of the first film 14, covering the surface of the convex portion 18 by, for example, spin coating. The third film 20 is preferably made of spin-on-glass.

Next, in FIG. 1E, the third film 20 is dry-etched by, for example, plasma dry etching to remove part of the third film 20 and reveal the upper surface of the convex portion 18. In plasma dry etching,  $\text{CF}_4$ ,  $\text{O}_2$  or  $\text{SF}_6$  are applied as the main etching gases.

Next, in FIG. 1F, dry etching, for example, plasma dry etching is applied, with  $\text{O}_2$  as the main etching gas and the third film 20 as the etching mask, to remove the convex portion 18 and the first film 14 thereunder, forming a via

corresponding to the activated device 12, passing through the third film 20 and the first film 14. The via serves as a nozzle orifice of the present invention.

**Second Embodiment**

5 FIGs. 2A to 2F are sectional diagrams of a self-aligned fabrication process for a nozzle plate of an inkjet print head according to the second embodiment. In FIG. 2A, a silicon substrate 10 is provided with at least one activated device 12, such as a thin-film heater, and then covered with  
10 a first film 14 by laminating or any other deposition type. Preferably, the first film 14 is a photosensitive polymeric material, such as epoxy, novolak, acrylate, polyimide, polyamide, or photosensitive polymer.

Next, in FIG. 2B, the first film 14 is covered with a  
15 second film 16 by laminating or other deposition method. Preferably, the second film 16 is also a photosensitive polymeric material, such as epoxy, novolak, acrylate, polyimide, polyamide, or photosensitive polymer.

Next, in FIG. 2C, using exposure and development on a  
20 predetermined area of the second film 16, a convex portion 18 is formed on the surface of the first film 14. By controlling the degree of exposure, the side wall of the convex portion 18 cross-section is formed in an arc shape, as shown in FIG. 1C.

25 Next, in FIG. 2D, a third film 20 is formed on the exposed surface of the first film 14, covering the surface of the convex portion 18 by, for example, spin coating. The third film 20 is preferably made of spin-on-glass.

Next, in FIG. 2E, a part of the third film 20 covering  
30 the upper surface of the convex portion 18 is removed by

photolithography to reveal the upper surface of the convex portion 18.

Next, in FIG. 2F, dry etching, for example, plasma dry etching is performed, with O<sub>2</sub> as the main etching gas and 5 the third film 20 as the etching mask, to remove the convex portion 18 and the first film 14 thereunder, forming a via corresponding to the activated device 12, passing through the third film 20 and the first film 14. The via serves as a nozzle orifice of the present invention.

10 Compared with conventional nozzle plates formed using electroforming, the present invention employs laminating, photolithography and etching to form the nozzle orifice in the third film 20 and first film 14. The diameter of the nozzle orifice can be narrowed to approximately 1μm and the 15 number of the nozzle orifices in one row can reach more than 10000, thus increasing the density of the nozzle orifice pattern. Also, by directly forming nozzle orifices on the substrate 10, the conventional requirement of precise alignment between the nozzle orifices (on the metal nozzle plate) and the activated devices (on the substrate) in an 20 electroforming step is avoided, and yield down resulting from misalignment is prevented. Moreover, the arrangement of adjacent nozzle orifices can be effectively controlled; by appropriately selecting the materials of the first film 25 14 and the third film 20 to be hydrophilic and hydrophobic respectively, the inkjet printing mechanism is facilitated, providing high-resolution inkjet performance. Furthermore, since photolithography and etching are directly performed on the substrate 10 and only easily controllable steps (e.g. 30 isotropic dry etching) are involved, procedure is thus

simplified, process costs are lowered, and commercialized mass production is enabled.

While the invention has been described by way of example and in terms of the preferred embodiments, it is to 5 be understood that the invention is not limited to the disclosed embodiments. To the contrary, it is intended to cover various modifications and similar arrangements (as would be apparent to those skilled in the art). Therefore, the scope of the appended claims should be accorded the 10 broadest interpretation so as to encompass all such modifications and similar arrangements.